

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









ON Semiconductor®

FDS8984-F085

N-Channel PowerTrench[®] MOSFET 30V, 7A, 23m Ω

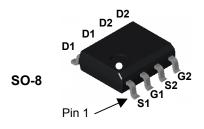
General Description

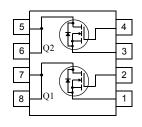
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{\text{DS(ON)}}$ and fast switching speed.

Features

- Max $r_{DS(on)} = 23m\Omega$, $V_{GS} = 10V$, $I_D = 7A$
- Max $r_{DS(on)} = 30m\Omega$, $V_{GS} = 4.5V$, $I_D = 6A$
- Low gate charge
- 100% R_G tested
- Qualified to AEC Q101
- RoHS Compliant







MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DS}	Drain to Source Voltage	30	V
V_{GS}	Gate to Source Voltage	±20	V
	Drain Current Continuous (Note 1a)	7	Α
ID	Pulsed	30	Α
E _{AS}	Single Pulse Avalache Energy (Note 2)	32	mJ
В	Power Dissipation for Single Operation	1.6	W
P_{D}	Derate above 25°C	13	mW/°C
T _J , T _{STG}	Operating and Storage Temperature	-55 to 150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS8984	FDS8984-F085	SO-8	330mm	12mm	2500 units

Max

Тур

Min

Units

Electrical Characteristics T_J = 25°C unless otherwise noted

Parameter

Off Char	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25°C		23		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24V$ $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			1 250	μА
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA

Test Conditions

On Characteristics (Note 3)

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.7	2.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25°C		- 4.3		mV/°C
r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = 10V, I_D = 7A$		19	23	
		$V_{GS} = 4.5V, I_D = 6A$		24	30	mΩ
	Stant to obtained on redictation	$V_{GS} = 10V, I_D = 7A,$ $T_J = 125^{\circ}C$		26	32	11132

Dynamic Characteristics

C _{iss}	Input Capacitance	\\ -45\\\\ -0\\	475	635	pF
C _{oss}	Output Capacitance	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	100	135	pF
C _{rss}	Reverse Transfer Capacitance	- 1.0 V -2	65	100	pF
R_G	Gate Resistance	f = 1MHz	0.9	1.6	Ω

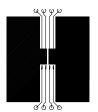
Switching Characteristics (Note 3)

t _{d(on)}	Turn-On Delay Time		5	10	ns
t _r	Rise Time	V _{DD} = 15V, I _D = 7A	9	18	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10V, R_{GS} = 33 Ω	42	68	ns
t _f	Fall Time		21	34	ns
Q _g	Total Gate Charge	$V_{DS} = 15V, V_{GS} = 10V,$ $I_{D} = 7A$	9.2	13	nC
Q_g	Total Gate Charge	$V_{DS} = 15V, V_{GS} = 5V,$	5.0	7	nC
Q _{gs}	Gate to Source Gate Charge	I _D = 7A	1.5		nC
Q_{gd}	Gate to Drain "Miller" Charge		2.0		nC

Drain-Source Diode Characteristics

V	Source to Drain Diode Voltage	I _{SD} = 7A	0.9	1.25	V
V_{SD}	Source to Drain Diode Voltage	I _{SD} = 2.1A	0.8	1.0	V
t _{rr}	Diode Reverse Recovery Time	I _F = 7A, di/dt = 100A/μs		33	ns
Q_{rr}	Diode Reverse Recovery Charge			20	nC

13 R_{0,IA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0,IC} is guaranteed by design while R_{0,CA} is determined by the user's board design.



a) 78°C/W when mounted on a 0.5in^2 pad of 2 oz copper



လုပ္*ပ္* b) 125°C/W when mounted on a 0.02 in² pad of oz copper



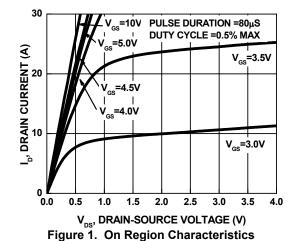
c) 135°C/W when mounted on a mounted on a minimun pad



Scale 1: 1 on letter size paper

- 2: Starting T $_J$ = 25°C, L = 1mH, I $_{AS}$ = 8A, V $_{DD}$ = 27V, V $_{GS}$ = 10V. 3: Pulse Test:Pulse Width <300 μ S, Duty Cycle <2%.

Typical Characteristics T_J = 25°C unless otherwise noted



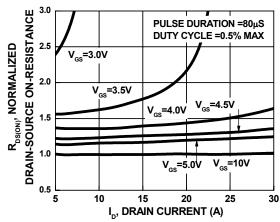


Figure 2. On-Resistance vs Drain Current and Gate Voltage

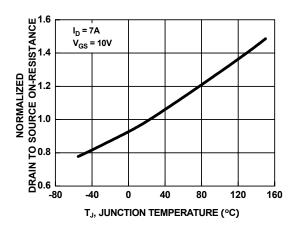


Figure 3. On Resistance vs Temperature

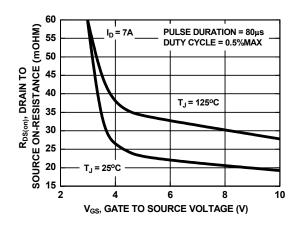
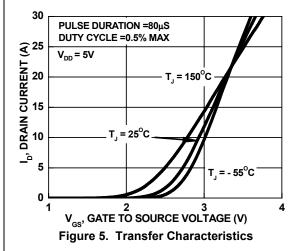


Figure 4. On-Resistance vs Gate to Source Votlage



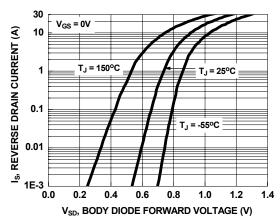


Figure 6. Source to Drain Diode Forward Voltage vs Source Current



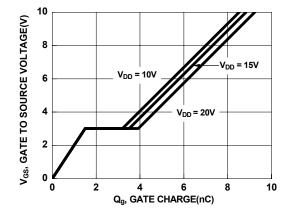


Figure 7. Gate Charge Characteristics

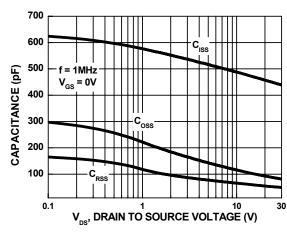


Figure 8. Capacitance vs Drain to Source Voltage

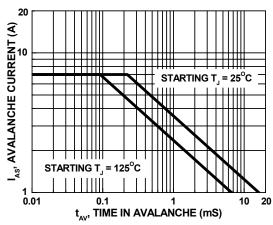


Figure 9. Unclamped Inductive Switching Capability

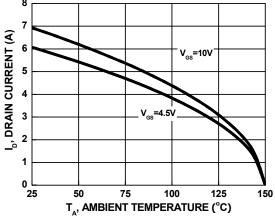


Figure 10. Maximum Continuous Drain Current vs
Ambient Temperature

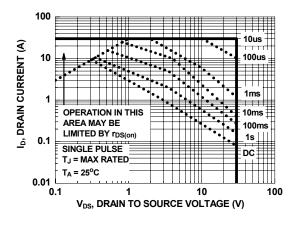


Figure 11. Forward Bias Safe Operating Area

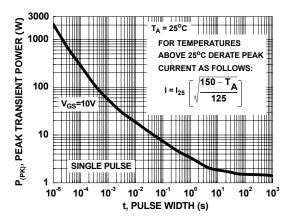


Figure 12. Single Pulse Maximum Power Dissipation

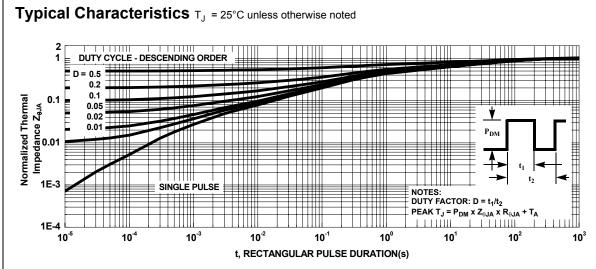


Figure 13. Transient Thermal Response Curve

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hol

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Phone: 421 33 790 2910

Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative